

# **BAY72**



DO-35 Color Band Denotes Cathode

# **Small Signal Diode**

**Absolute Maximum Ratings\***  $T_A = 25$ °C unless otherwise noted

Symbol	Parameter	Value	Units
$V_{RRM}$	Maximum Repetitive Reverse Voltage	125	V
I <sub>F(AV)</sub>	Average Rectified Forward Current	200	mA
I <sub>FSM</sub>	Non-repetitive Peak Forward Surge Current Pulse Width = 1.0 second Pulse Width = 1.0 microsecond	1.0 4.0	A A
T <sub>stg</sub>	Storage Temperature Range	-65 to +200	°C
T <sub>J</sub>	Operating Junction Temperature	175	°C

 $<sup>{}^{\</sup>bigstar} \text{These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.}$ 

### **Thermal Characteristics**

Symbol	Parameter	Value	Units
P <sub>D</sub>	Power Dissipation	500	mW
$R_{\theta JA}$	R <sub>eJA</sub> Thermal Resistance, Junction to Ambient		°C/W

## **Electrical Characteristics** T<sub>A</sub> = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Max	Units
$V_R$	Breakdown Voltage	$I_R = 100  \mu A$	125		V
V <sub>F</sub>	Forward Voltage	$I_F = 1.0 \text{ mA}$ $I_F = 10 \text{ mA}$ $I_F = 50 \text{ mA}$ $I_F = 100 \text{ mA}$	0.51 0.63 0.73 0.78	0.64 0.78 0.92 1.0	V V V
I <sub>R</sub>	Reverse Current	$V_R = 100 \text{ V}$ $V_R = 100 \text{ V}, T_A = 125^{\circ}\text{C}$		100 100	nA μA
Ст	Total Capacitance	$V_R = 0, f = 1.0 \text{ MHz}$		5	pF
t <sub>rr1</sub>	Reverse Recovery Time	$I_F = I_R = 30 \text{ mA}, I_{rr} = 1.0 \text{ mA}$		50	ns
t <sub>rr2</sub>	Reverse Recovery Time	$I_F = 30 \text{ mA}, V_R = 35 \text{ V}$		400	ns

<sup>1)</sup> These ratings are based on a maximum junction temperature of 200 degrees C.
2) These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

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